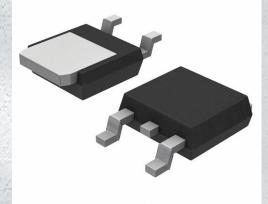


FDD6680 Datasheet

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DiGi Electronics Part Number	FDD6680-DG
Manufacturer	onsemi
Manufacturer Product Number	FDD6680
Description	MOSFET N-CH 30V 12A/46A DPAK
Detailed Description	N-Channel 30 V 12A (Ta), 46A (Tc) 3.3W (Ta), 56W (Tc) Surface Mount TO-252AA

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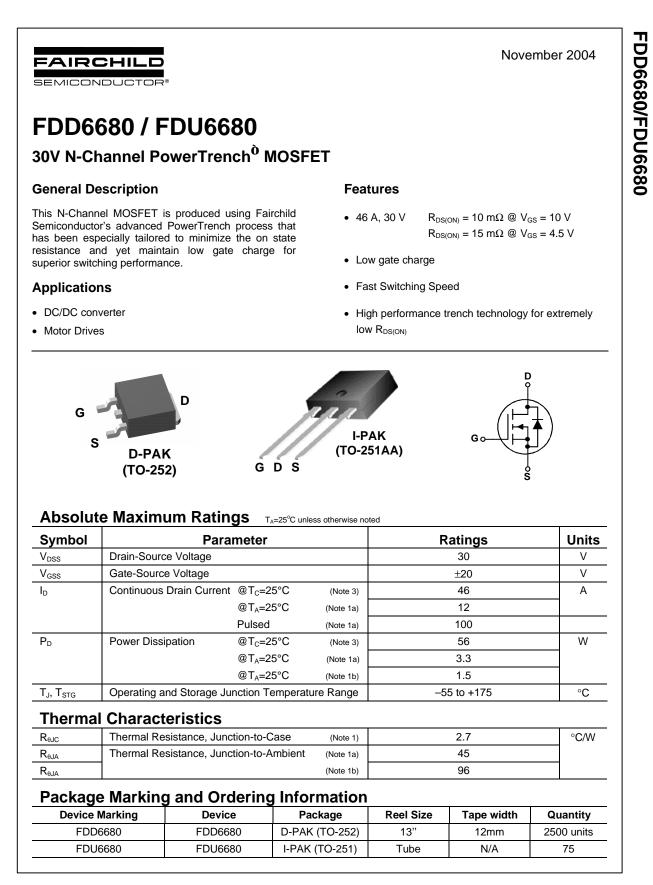


Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FDD6680	onsemi
Series:	Product Status:
PowerTrench®	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
30 V	12A (Ta), 46A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
4.5V, 10V	10mOhm @ 12A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
3V @ 250µA	18 nC @ 5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	1230 pF @ 15 V
FET Feature:	Power Dissipation (Max):
	3.3W (Ta), 56W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 175°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
TO-252AA	TO-252-3, DPAK (2 Leads + Tab), SC-63
Base Product Number:	
FDD668	

Environmental & Export classification

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8541.29.0095

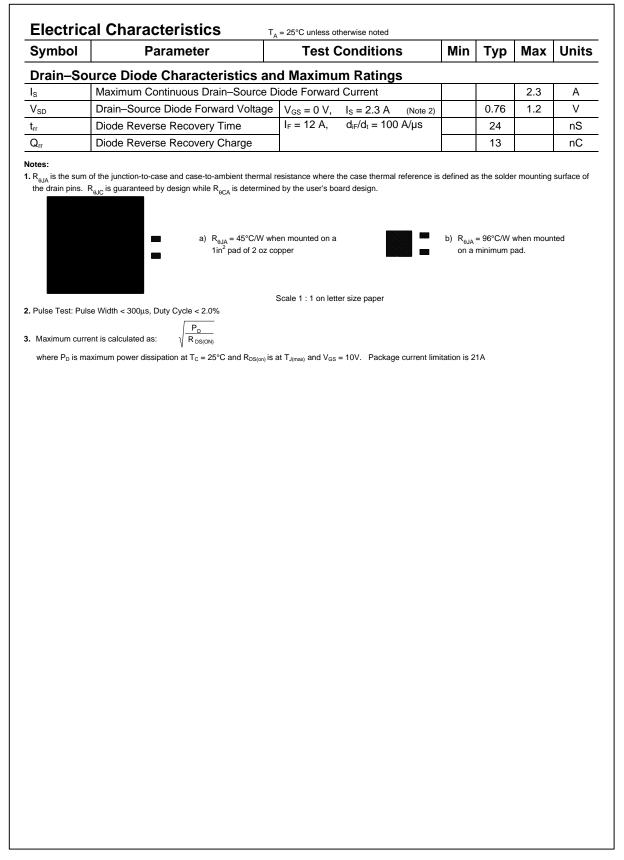


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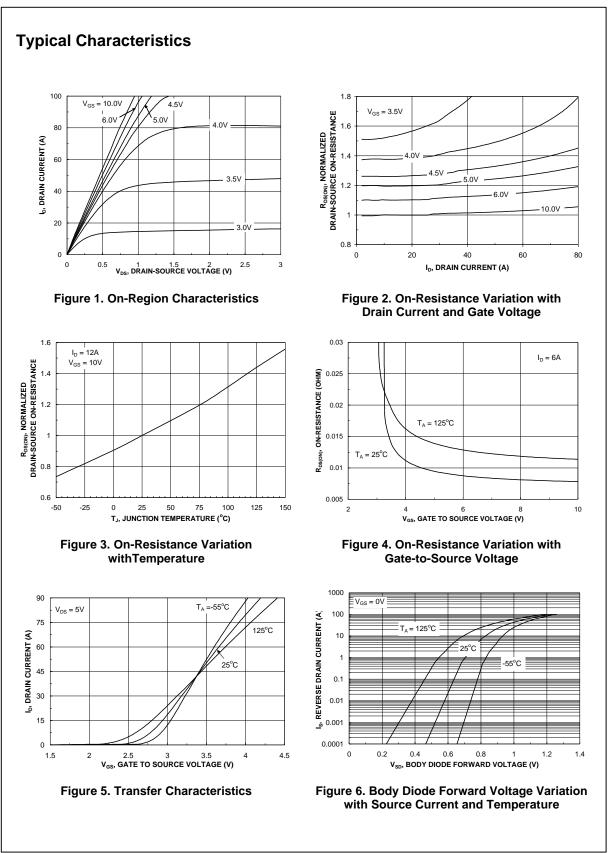
FDD6680/FDU6680 Rev. C1(W)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	urce Avalanche Ratings (Note	2)				
E _{AS}	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 25 \text{ V}$, $I_D = 12 \text{ A}$			180	mJ
I _{AS}	Drain-Source Avalanche Current				12	Α
-	acteristics	I		1	1	
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	30			V
	Breakdown Voltage Temperature	$I_D = 250 \ \mu$ A,Referenced to 25°C		24		mV/°C
ΔT_{J}	Coefficient					, •
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μΑ
I _{GSS}	Gate–Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, \qquad I_{\text{D}} = 250 \; \mu\text{A}$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		-5		mV/°C
R _{DS(on)}	Static Drain–Source	$V_{GS} = 10 \text{ V}, I_{D} = 12 \text{ A}$		7.7	10	mΩ
	On-Resistance	$V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		9.9	15	
1	On State Drain Current	$V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}, T_J = 125^{\circ}\text{C}$	50	11.4	16	•
I _{D(on)}	On–State Drain Current Forward Transconductance	$V_{GS} = 10 V$, $V_{DS} = 5 V$	50	47		A S
g _{FS}		$V_{DS} = 10 V$, $I_{D} = 12 A$		47		3
	Characteristics	1	-			r
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		1230		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		325		pF
Crss	Reverse Transfer Capacitance			150		pF
R _G	Gate Resistance	$V_{GS} = 15 \text{ mV}, \text{ f} = 1.0 \text{ MHz}$		1.5		Ω
Switchin	g Characteristics (Note 2)			-	-	•
t _{d(on)}	Turn–On Delay Time			10	19	ns
tr	Turn–On Rise Time	$V_{DD} = 15 V, \qquad I_D = 1 A,$		7	13	ns
t _{d(off)}	Turn–Off Delay Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \ \Omega$		29	46	ns
t _f	Turn–Off Fall Time			12	21	ns
Qg	Total Gate Charge	$V_{DS} = 15V$, $I_D = 12 A$,		13	18	nC
Q _{gs}	Gate–Source Charge	$V_{\rm GS} = 5 V$		3.5		nC
Q _{gd}	Gate–Drain Charge			5.1		nC

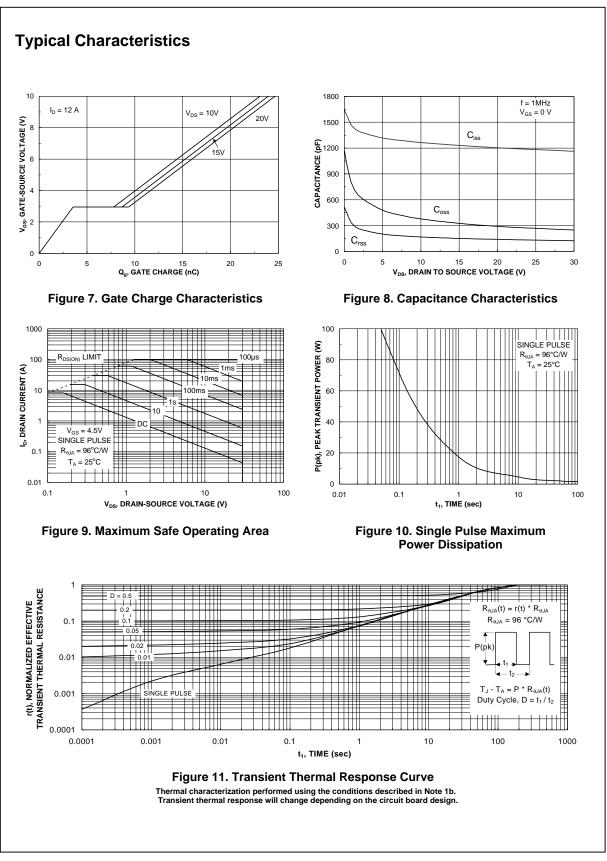
FDD6680/FDU6680



FDD6680/FDU6680



FDD6680/FDU6680 Rev. C1(W)



FDD6680/FDU6680

FDD6680/FDU6680 Rev. C1(W)

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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
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Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.



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